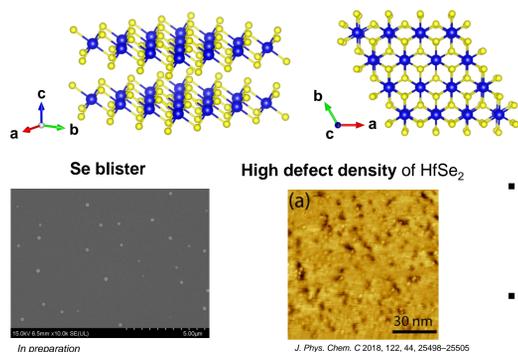


Abstract

Hafnium diselenide (HfSe₂) is one of the two-dimensional transition metal dichalcogenides (2D TMD), which maintains very **high electron mobility (~3,500 cm²/Vs)** at room temperature compared to Si (~1,350 cm²/Vs), even when the device channel scale is extremely reduced. However, in previously reported studies, **the mobility of HfSe₂ was experimentally very low**, which is considered a major barrier in practical electronic applications. The **very poor air stability of HfSe₂**, especially the formation of **selenium blisters** that degrade the surface quality and stoichiometry when exposed to air, is one of the main reasons for its low electron mobility. In this study, we successfully deposited HfSe₂ thin films with ***in-situ* boron nitride (BN) passivation** that efficiently prevents the formation of selenium blisters. **Optimized stoichiometry of HfSe₂ thin films** was achieved by **supplying hafnium metal flux through laser ablation and sufficient selenium flux through thermal evaporation**. It was revealed that as-grown HfSe₂ thin film has out-of-plane **oriented 1T phase** based on X-ray diffraction (XRD) and Raman spectrum analysis. **Furthermore, we will investigate its electrical properties through the fabrication of field effect transistors**. We believe that our study will pave the way for the next-generation 2D electronics through follow-up studies.

1. Introduction

Low electron mobility of HfSe₂



- Theoretical mobility: **3,579 cm²/V-s**
- Experimental mobility: **0.22~4 cm²/V-s**

Nano Res. 2014, 7(12): 1731-1737
Sci. Adv. 2017;3:e1700481
Appl. Phys. Lett. 106: 143108 (2015)
Nanoscale, 2017, 9, 1645-1652

- A high defect density (black dots) are observed on exfoliated single crystal HfSe₂ surface.
- The oxidation of HfSe₂ formation insulating HfO_x and spherical Se blisters are created.

Defects and oxidation are considered to induce scattering, leading to low electron mobility.

Motivation

Amorphous boron nitride (a-BN) for passivation

- Capping layer to prevent oxidation of TMD
- Improvement of the electrical characteristic of TMD
- Applicability of PLD methods to variable material

Recently reported defect engineering

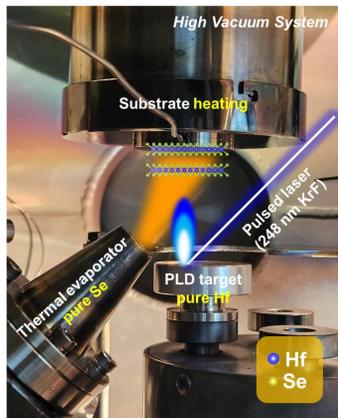
- The way that control defects is mostly through **post-processing**.
- The approach of defect engineering is **biased toward increasing defects**.

- In-situ* passivation**
- In-situ* defect engineering**
- Defect engineering through a unified approach, whether to increase or decrease**
- High crystalline TMD**

Hybrid PLD system

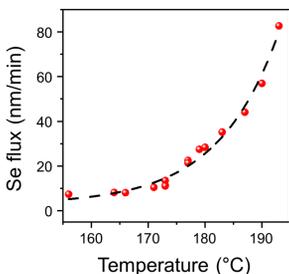
2. Methods

Hybrid PLD system



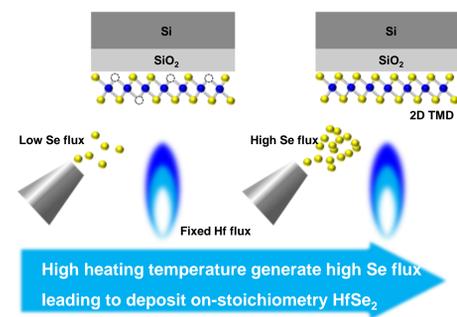
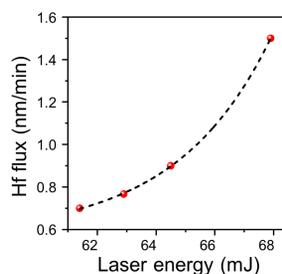
Thermal Evaporator

- Dependent on Temperature
- Temp. ↑ → Se flux up ↑



Pulse Laser Deposition

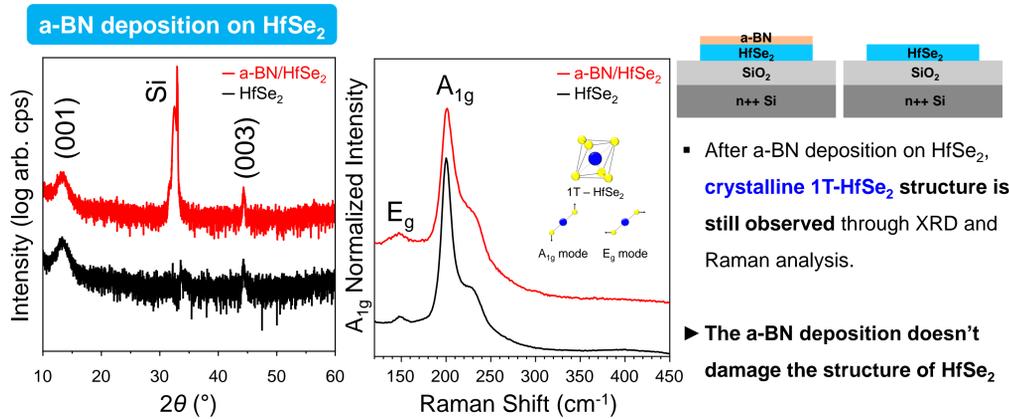
- Dependent on Laser energy
- Laser energy ↑ → Hf flux ↑



- TMD deposition is driven by **metal flux & Se flux**.
- The composition of HfSe₂ can be controlled by the Se/Hf flux adjusted the **Se heating temperature**.
- High-quality thin film is deposited using a **single element precursor** in a **high vacuum chamber**.
- PLD chamber can load multiple targets → ***In situ* passivation technique** (a-BN) is possible

3. Results & Discussion

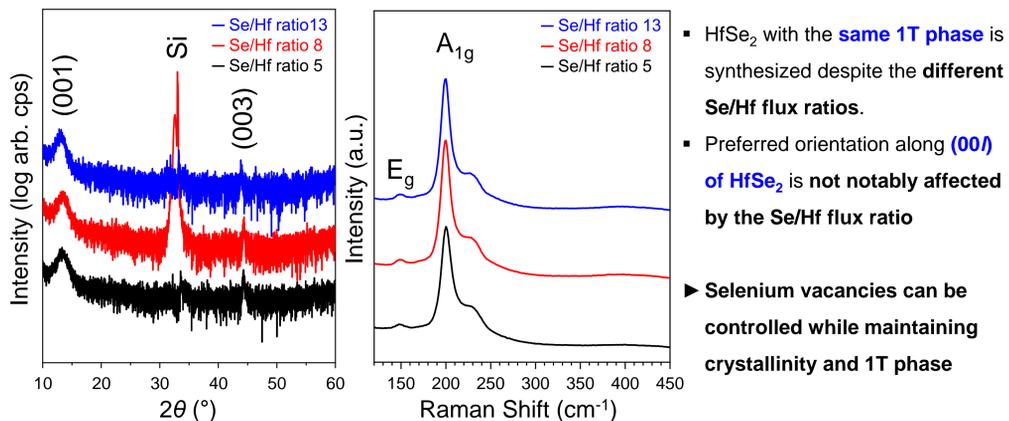
3-1) Structural Characterization



After a-BN deposition on HfSe₂, **crystalline 1T-HfSe₂ structure is still observed** through XRD and Raman analysis.

The a-BN deposition doesn't damage the structure of HfSe₂

Different Se/Hf flux ratio

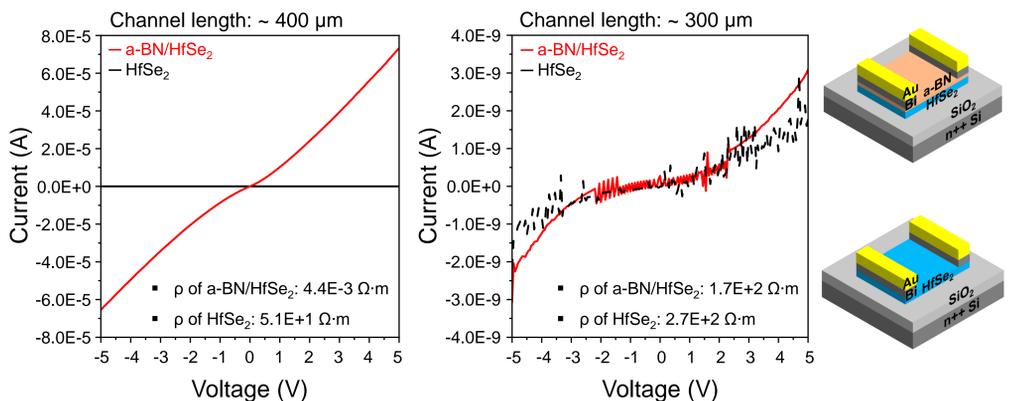


HfSe₂ with the **same 1T phase** is synthesized despite the **different Se/Hf flux ratios**.

Preferred orientation along **(00)** of HfSe₂ is not notably affected by the Se/Hf flux ratio

Selenium vacancies can be controlled while maintaining crystallinity and 1T phase

3-2) Electrical Characterization



- The resistivity (ρ) of HfSe₂ with a-BN passivation layer was lower than that of bare HfSe₂.
- The a-BN layer is thought to maintain low resistance by **preventing the production of insulating HfO_x** when HfSe₂ is oxidized.

4. Further works

- Verifying HfSe₂ composition using XPS analysis with variable Se/Hf flux ratio sample
- Developing a fabrication process for HfSe₂ channel FET and analyzing the transfer and output curve
- Comparison of device performance of HfSe₂ from variable Se/Hf flux ratio
- Assessing the passivation effect by aging test and checking the formation of Se blister between a-BN/HfSe₂ and bare HfSe₂

5. Conclusion

- The hybrid PLD system demonstrates the capability to deposit crystalline 1T-HfSe₂ on Si while varying Se/Hf flux ratios.
- Deposition of the a-BN layer *via* PLD does not damage the crystalline 1T-HfSe₂ structure, allowing *in situ* passivation in this system.
- Analyzing the resistivity of a-BN/HfSe₂ and HfSe₂, the a-BN layer is considered to act as a passivation layer, preventing the formation of insulating HfO_x.